

N-CHANNEL SILICON POWER MOS-FET

F-II SERIES

勝特力材料 886-3-5753170
 勝特力电子(上海) 86-21-54151736
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 Http://www.100y.com.tw

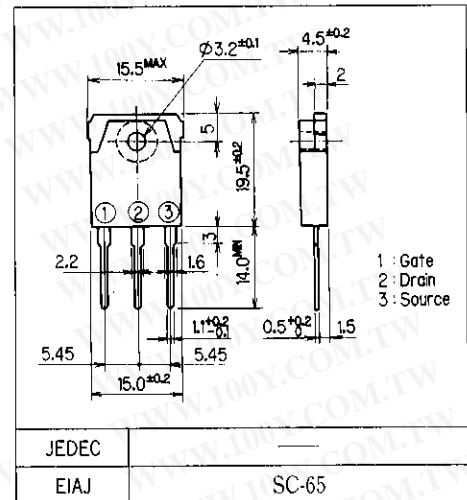
Features

- High speed switching
- Low on-resistance
- No secondary breakdown
- Low driving power
- High voltage
- $V_{GSS} = \pm 30V$ Guarantee
- Avalanche-proof

Applications

- Switching regulators
- UPS
- D-C-DC converters
- General purpose power amplifier

Outline Drawings

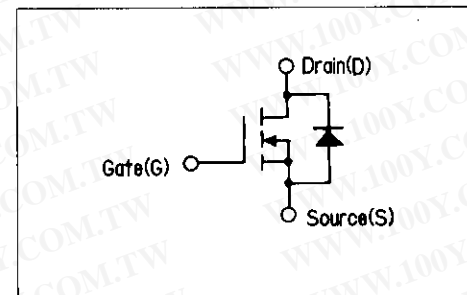


Max. Ratings and Characteristics

Absolute Maximum Ratings ($T_c = 25^\circ C$)

Items	Symbols	Ratings	Units
Drain-source voltage	V_{DSS}	800	V
Continuous drain current	I_D	7	A
Pulsed drain current	$I_{D(puls)}$	21	A
Continuous reverse drain current	I_{DR}	7	A
Gate-source peak voltage	V_{GSS}	± 30	V
Max. power dissipation	P_D	125	W
Operating and storage temperature range	T_{ch}	150	$^\circ C$
	T_{stg}	$-55 \sim +150$	$^\circ C$

Equivalent Circuit Schematic



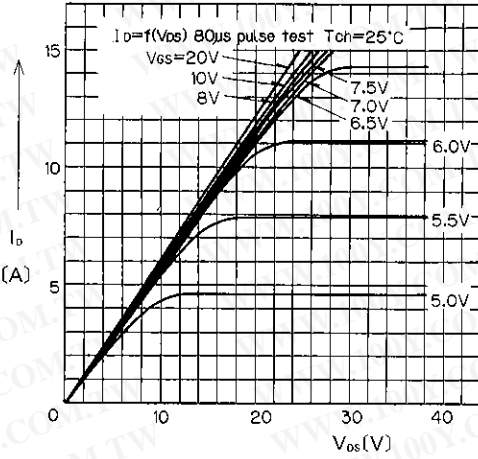
Electrical Characteristics ($T_c = 25^\circ C$)

Items	Symbols	Test Conditions	Min.	Typ.	Max.	Units
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = 1mA$ $V_{GS} = 0V$	800			V
Gate threshold voltage	$V_{GS(th)}$	$I_D = 1mA$ $V_{DS} = V_{GS}$	2.5	3.5	5.0	V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 800V$ $V_{GS} = 0V$ $T_{ch} = 25^\circ C$		10	500	μA
		$V_{DS} = 800V$ $V_{GS} = 0V$ $T_{ch} = 125^\circ C$		0.2	1.0	mA
Gate-source leakage current	I_{GSS}	$V_{GS} = \pm 30V$ $V_{DS} = 0V$		10	100	nA
Drain-source on-state resistance	$R_{DS(on)}$	$I_D = 3A$ $V_{GS} = 10V$		1.7	2.2	Ω
Forward transconductance	g_{fs}	$I_D = 3A$ $V_{DS} = 25V$	2.0	4.5		S
Input capacitance	C_{iss}	$V_{DS} = 25V$		1200	1800	pF
Output capacitance	C_{oss}	$V_{GS} = 0V$		140	210	
Reverse transfer capacitance	C_{rss}	$f = 1MHz$		50	75	
Turn-on time t_{on} ($t_{on} + t_{d(on)} + t_r$)	$t_{d(on)}$	$V_{CC} = 600V$ $I_D = 10A$		35	55	ns
			$V_{GS} = 10V$		110	
	t_r	$R_G = 25\Omega$		150	230	
				100	150	
Turn-off time t_{off} ($t_{d(off)} + t_f$)	$t_{d(off)}$					
	t_f					
Diode forward on-voltage	V_{SD}	$I_F = 2 \times I_{DR}$ $V_{GS} = 0V$ $T_{ch} = 25^\circ C$		1.0	1.5	V
Reverse recovery time	t_{rr}	$I_F = I_{DR}$ $dI/dt = 100A/\mu s$ $T_{ch} = 25^\circ C$		800		ns

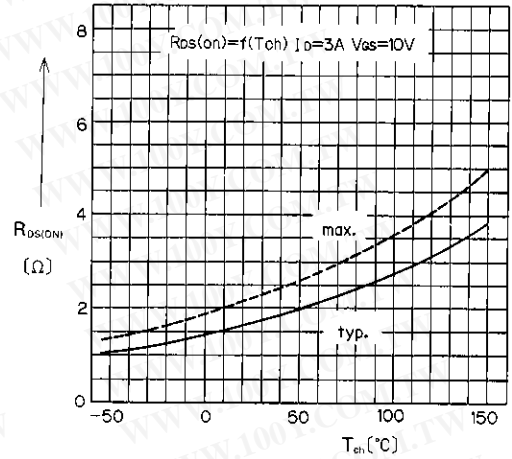
Thermal Characteristics

Items	Symbols	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance	$R_{th(ch-a)}$	channel to air			35.0	$^\circ C/W$
	$R_{th(ch-c)}$	channel to case			1.0	$^\circ C/W$

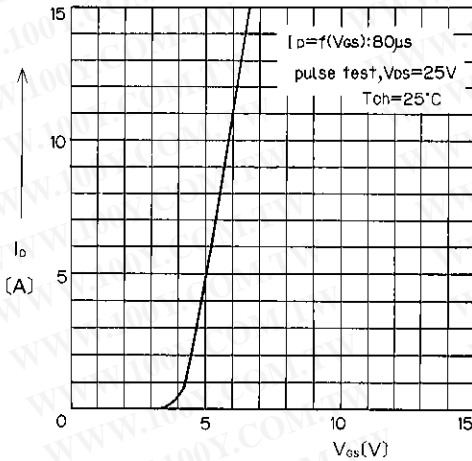
■ Characteristics



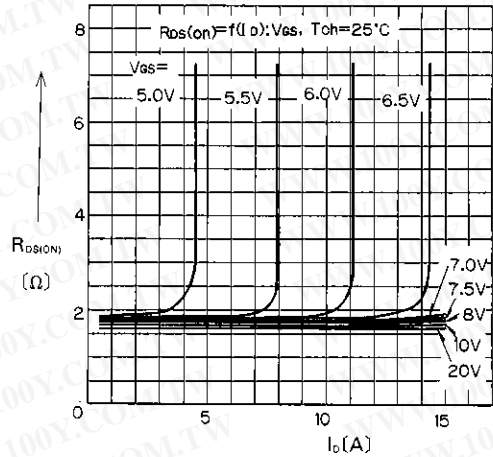
Typical Output Characteristics



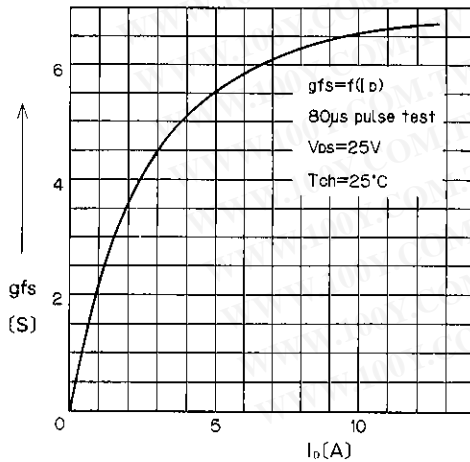
On State Resistance vs. T_{ch}



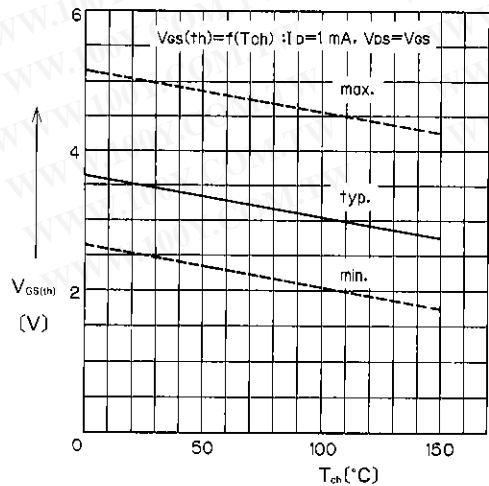
Typical Transfer Characteristics



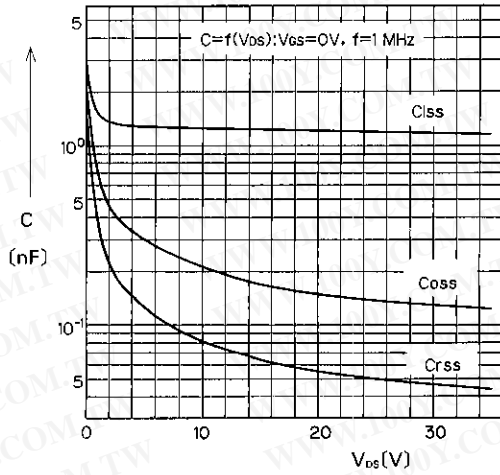
Typical Drain-Source on State Resistance vs. I_D



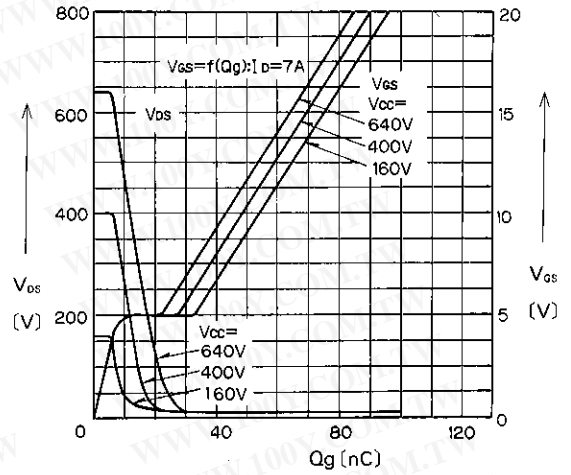
順伝達コンダクタンスドレイン電流 (標準値)



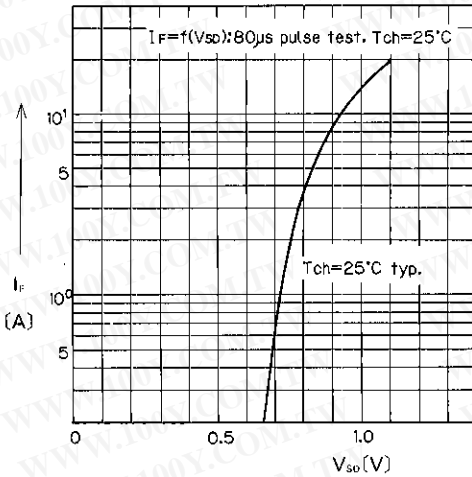
Gate Threshold Voltage vs. T_{ch}



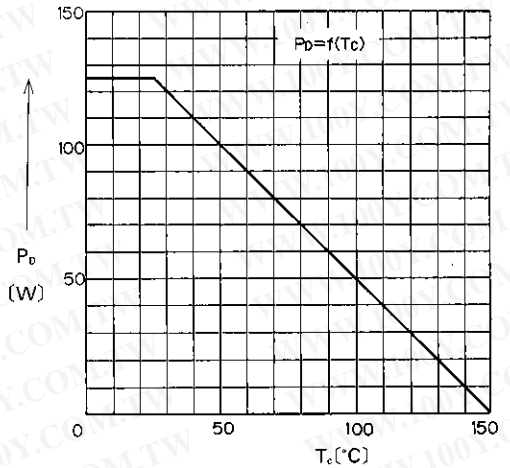
Typical Capacitance vs. V_{DS}



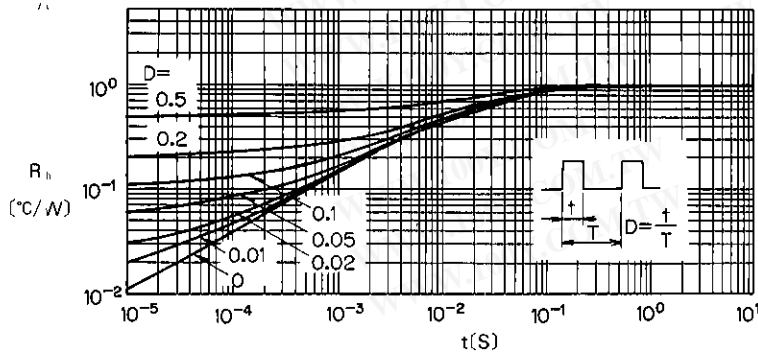
Typical Input Charge



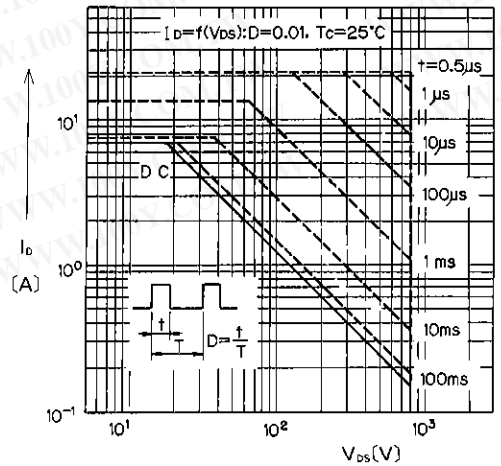
Forward Characteristics of Reverse Diode



Allowable Power Dissipation vs. T_c



Transient Thermal Impedance



Safe Operating Area

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